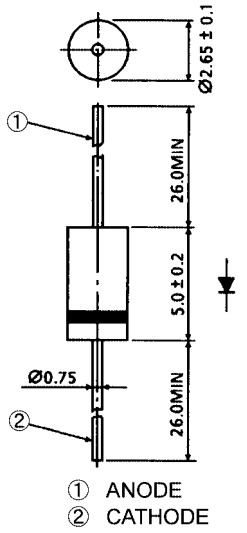
TOSHIBA Fast Recovery Diode Silicon Diffused Type

TVR2B,TVR2G,TVR2J

TV Applications (fast recovery)

- Average Forward Current: $I_{F\ (AV)}$ = 0.5 A (Ta = 50°C)
- Repetitive Peak Reverse Voltage: V_{RRM} = 100 to 600 V
- Reverse Recovery Time: t_{rr} = 5 to 20 μs
- Plastic Mold Type.

Unit: mm



JEDEC	DO-41
JEITA	—
TOSHIBA	3-3C1A

Weight: 0.3 g (typ.)

Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Repetitive peak reverse voltage	TVR2B	V_{RRM}	100	V
	TVR2G		400	
	TVR2J		600	
Reverse voltage (DC)	TVR2B	V_R	50	V
	TVR2G		300	
	TVR2J		500	
Average forward current (Ta = 50°C)		$I_{F\ (AV)}$	0.5	A
Peak one cycle surge forward current (non repetitive)		I_{FSM}	30 (50 Hz)	A
			33 (60 Hz)	
Junction temperature		T_j	−40 to 125	°C
Storage temperature range		T_{stg}	−40 to 125	°C

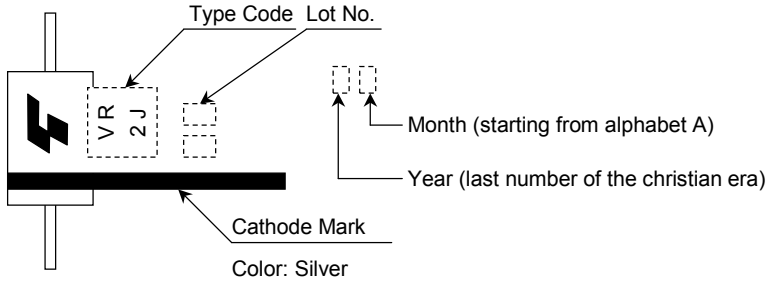
Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Peak forward voltage	V_{FM}	I_{FM} = 1.0 A	—	—	1.4	V
Repetitive peak reverse current	I_{RRM}	V_{RRM} = Rated	—	—	10	μA
Reverse recovery time	t_{rr}	I_F = 20 mA, I_R = 1 mA	5	—	20	μs
Forward recovery voltage	V_{fr}	I_F = 0.1 A, t_r = 100 ns, t_w = 5 μs	—	—	6	V

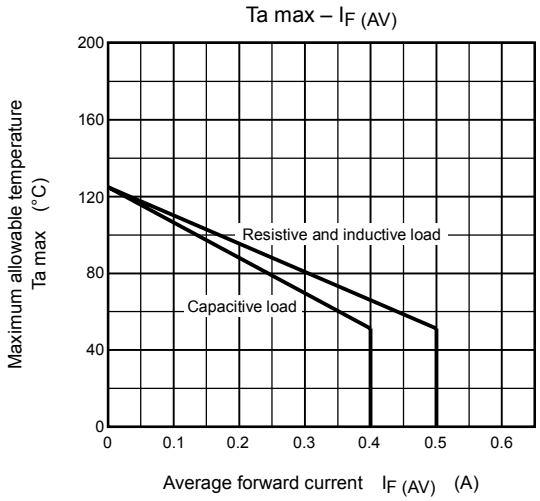
Note1: Soldering: 5 mm is the minimum to be kept between case and soldering part.

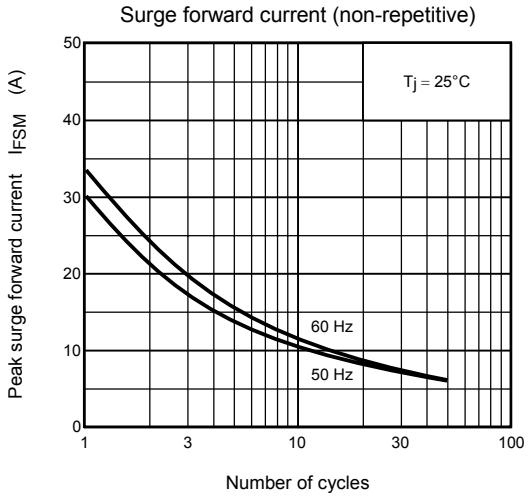
Note2: Lead bending: 5 mm is the minimum to be kept from the case when bend the lead wire.

Marking



Code	Type
VR2B	TVR2B
VR2G	TVR2G
VR2J	TVR2J





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